



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **11**

Number of Rows: **1**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	11
Number of Rows	1
Board-to-Board Configuration	Parallel

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.5 µm
Contact Layout	Inline



Mating Pin Diameter	.63 mm[.025 in]
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	3 A

Termination Features

Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.7 mm[.027 in]
Termination Method to PCB	Surface Mount

Mechanical Attachment

Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Bottom & Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer)

Dimensions

Connector Height	6.2 mm[.244 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	9 mm[.354 in]
PCB Thickness (Recommended)	1.4 – 2.4 mm[.055 – .094 in]

Usage Conditions

Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	700
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Packaging Method	Reel
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 1-826629-1  
11P AMPMODU II STIFT LEI



TE Part # 1-966710-1  
MODU II PIN HEADER, SGL ROW, SMD- 11 POS



TE Part # 1-826654-1  
11P MOD2 STIFT LEI

Also in the Series | AMPMODU HV-100/HV-190



Customers Also Bought

Documents

Product Drawings  
11P HV100 REC. CON, SMD, GOLD, BLISTER  
English

CAD Files  
3D PDF  
3D  
Customer View Model  
ENG\_CVM\_CVM\_1-1241152-1\_E.2d\_dxf.zip  
English  
Customer View Model  
ENG\_CVM\_CVM\_1-1241152-1\_E.3d\_igs.zip  
English  
Customer View Model  
ENG\_CVM\_CVM\_1-1241152-1\_E.3d\_stp.zip  
English

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Datasheets & Catalog Pages

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English